

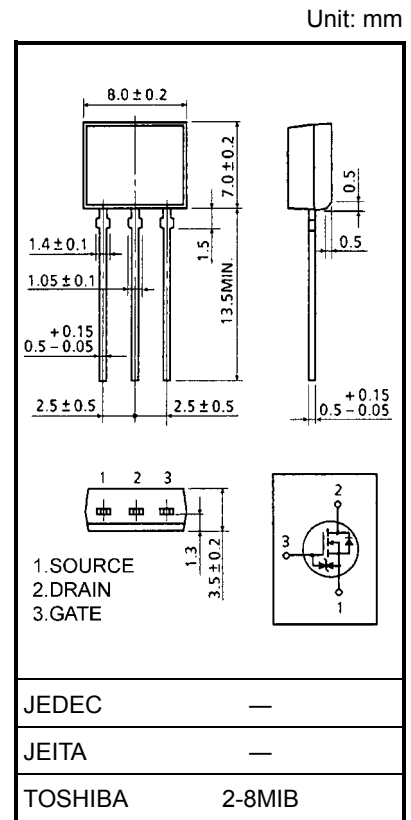
2SK3302

Switching Regulator, DC-DC Converter Applications

- Low drain-source ON resistance: $R_{DS(ON)} = 11.5 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 0.4 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \mu\text{A}$ (max) ($V_{DS} = 500 \text{ V}$)
- Enhancement-model: $V_{th} = 2.0\sim 4.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Characteristics | | Symbol | Rating | Unit |
|--|----------------|-----------|---------------|------------------|
| Drain-source voltage | | V_{DSS} | 500 | V |
| Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) | | V_{DGR} | 500 | V |
| Gate-source voltage | | V_{GSS} | ± 30 | V |
| Drain current | DC (Note 1) | I_D | 0.5 | A |
| | Pulse (Note 1) | I_{DP} | 1.5 | |
| Drain power dissipation | | P_D | 1.3 | W |
| Single pulse avalanche energy (Note 2) | | E_{AS} | 14.3 | mJ |
| Avalanche current | | I_{AR} | 0.5 | A |
| Repetitive avalanche energy (Note 3) | | E_{AR} | 0.13 | mJ |
| Channel temperature | | T_{ch} | 150 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | $-55\sim 150$ | $^\circ\text{C}$ |



Weight: 1.9 g (typ.)

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|----------------|------|--------------------|
| Thermal resistance, channel to ambient | $R_{th(ch-a)}$ | 96.1 | $^\circ\text{C/W}$ |

Note 1: Please use device on condition that the channel temperature is below 150°C .

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^\circ\text{C}$, $L = 100 \text{ mH}$, $R_G = 25 \Omega$, $I_{AR} = 0.5 \text{ A}$

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.

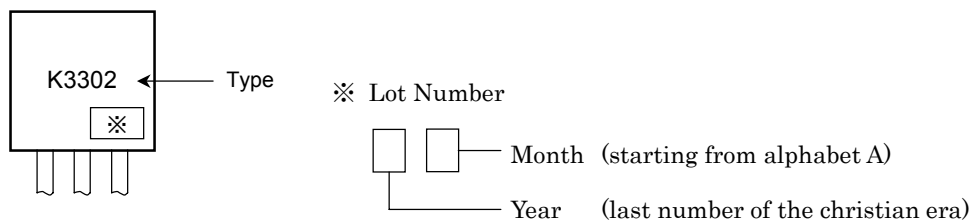
Electrical Characteristics (Ta = 25°C)

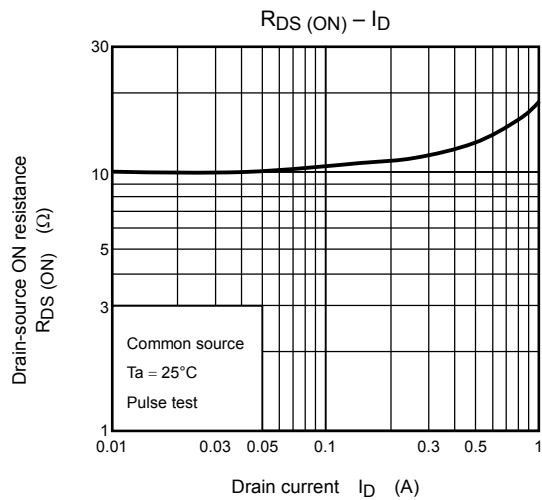
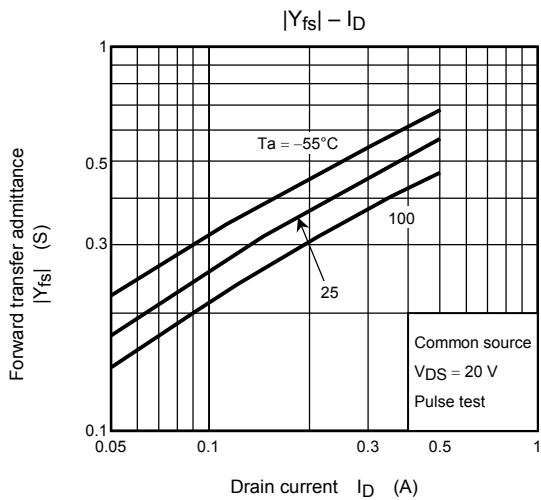
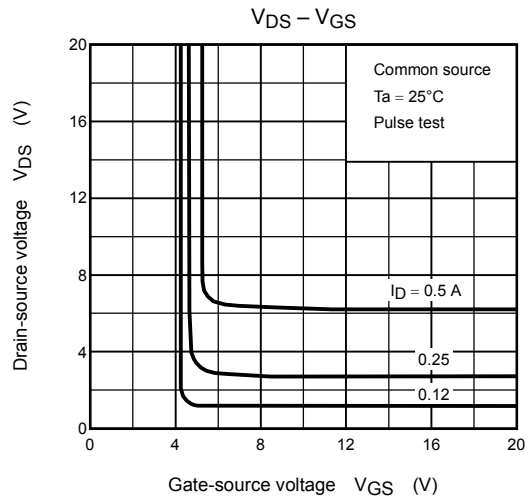
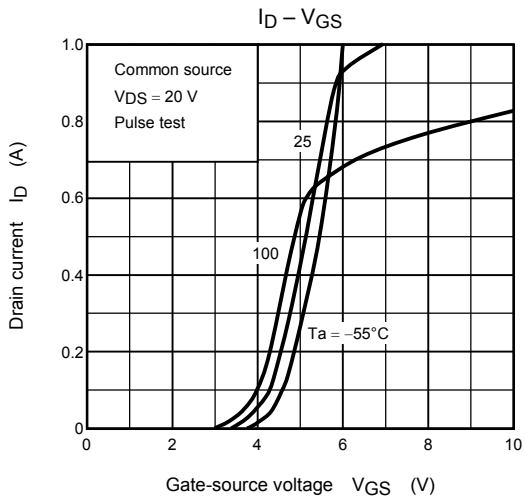
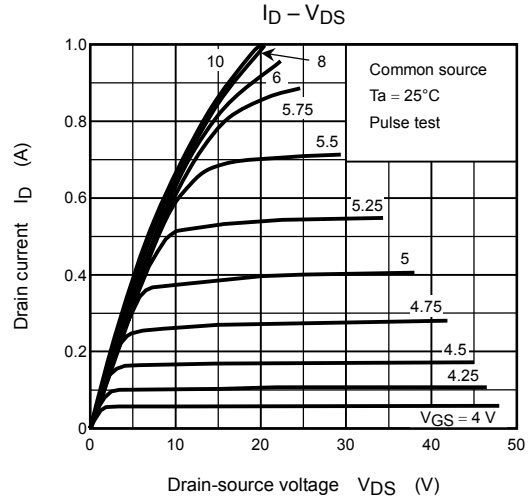
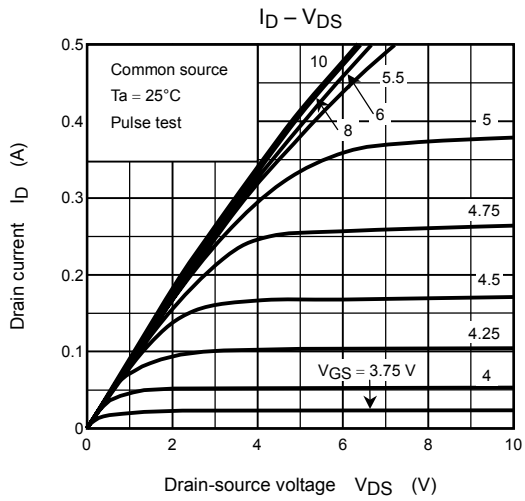
| Characteristics | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|---------------|---------------|---|----------|------|----------|---------------|
| Gate leakage current | | I_{GSS} | $V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$ | — | — | ± 10 | μA |
| Gate-source breakdown voltage | | $V_{(BR)GSS}$ | $I_G = \pm 10\ \mu\text{A}, V_{GS} = 0\text{ V}$ | ± 30 | — | — | V |
| Drain cut-OFF current | | I_{DSS} | $V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$ | — | — | 100 | μA |
| Drain-source breakdown voltage | | $V_{(BR)DSS}$ | $I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$ | 500 | — | — | V |
| Gate threshold voltage | | V_{th} | $V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$ | 2.0 | — | 4.0 | V |
| Drain-source ON resistance | | $R_{DS(ON)}$ | $V_{GS} = 10\text{ V}, I_D = 0.25\text{ A}$ | — | 10 | 18 | Ω |
| Forward transfer admittance | | $ Y_{fs} $ | $V_{DS} = 10\text{ V}, I_D = 0.25\text{ A}$ | 0.2 | 0.4 | — | S |
| Input capacitance | | C_{iss} | $V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | — | 75 | — | pF |
| Reverse transfer capacitance | | C_{rss} | | — | 7 | — | |
| Output capacitance | | C_{oss} | | — | 24 | — | |
| Switching time | Rise time | t_r | <p>$V_{GS} = 10\text{ V}$ 0 V $I_D = 0.25\text{ A}$ $R_L = 1\text{ k}\Omega$ $V_{DD} \approx 250\text{ V}$ Duty $\leq 1\%$, $t_w = 10\ \mu\text{s}$</p> | — | 11 | — | ns |
| | Turn-ON time | t_{on} | | — | 18 | — | |
| | Fall time | t_f | | — | 54 | — | |
| | Turn-OFF time | t_{off} | | — | 95 | — | |
| Total gate charge (gate-source plus gate-drain) | | Q_g | $V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 0.5\text{ A}$ | — | 3.8 | — | nC |
| Gate-source charge | | Q_{gs} | | — | 1.9 | — | |
| Gate-drain ("miller") charge | | Q_{gd} | | — | 1.9 | — | |

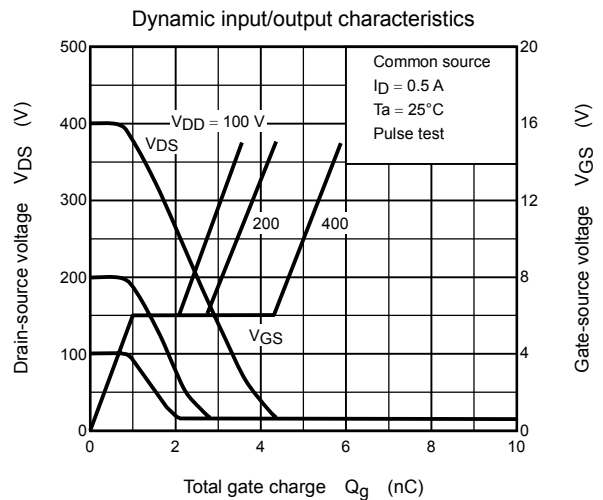
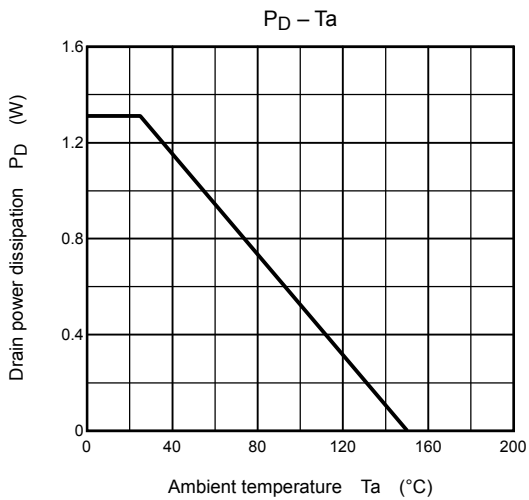
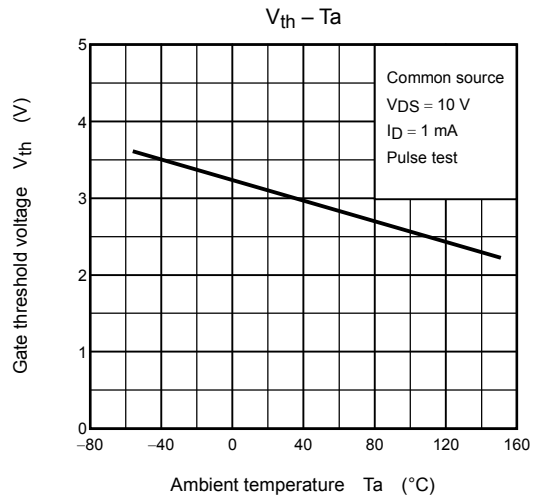
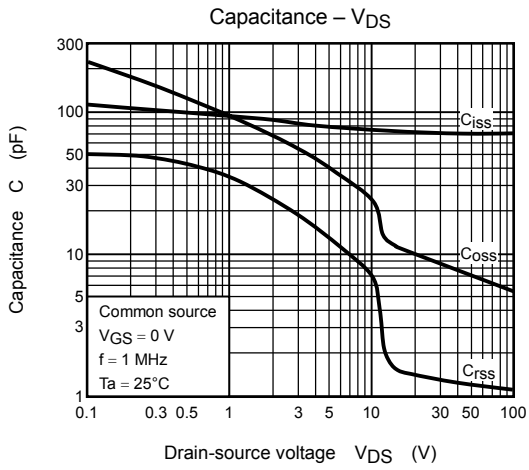
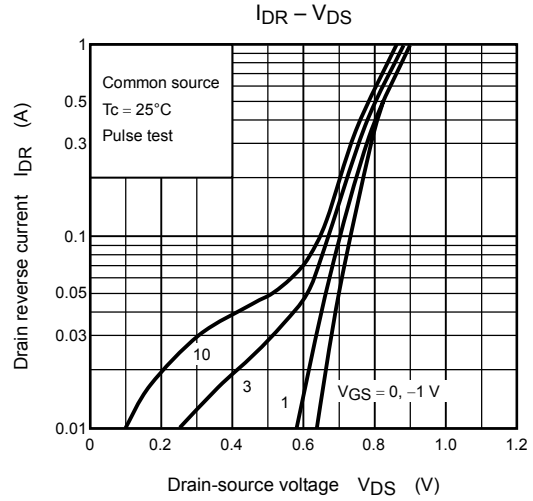
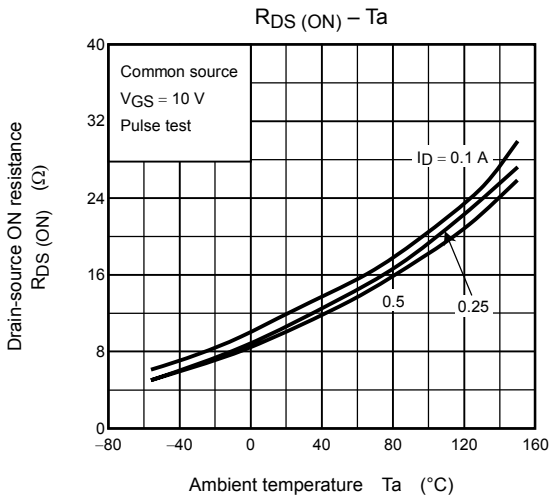
Source-Drain Ratings and Characteristics (Ta = 25°C)

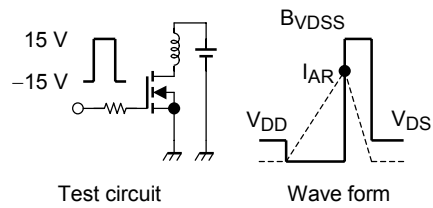
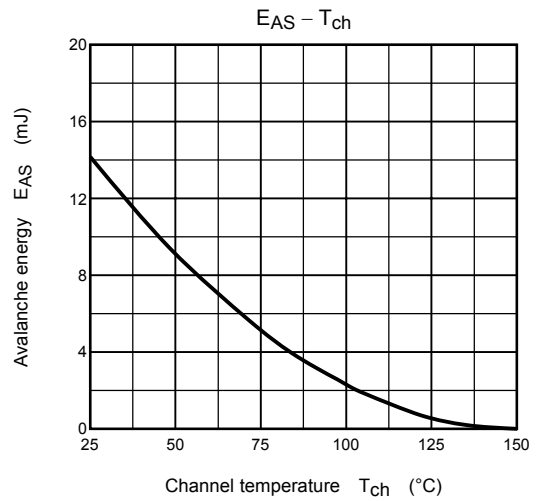
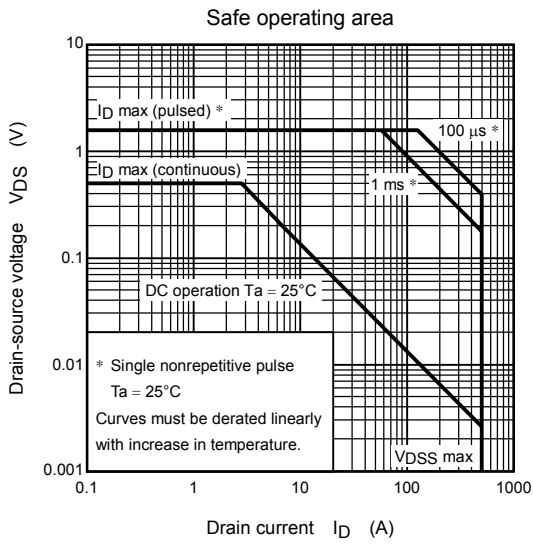
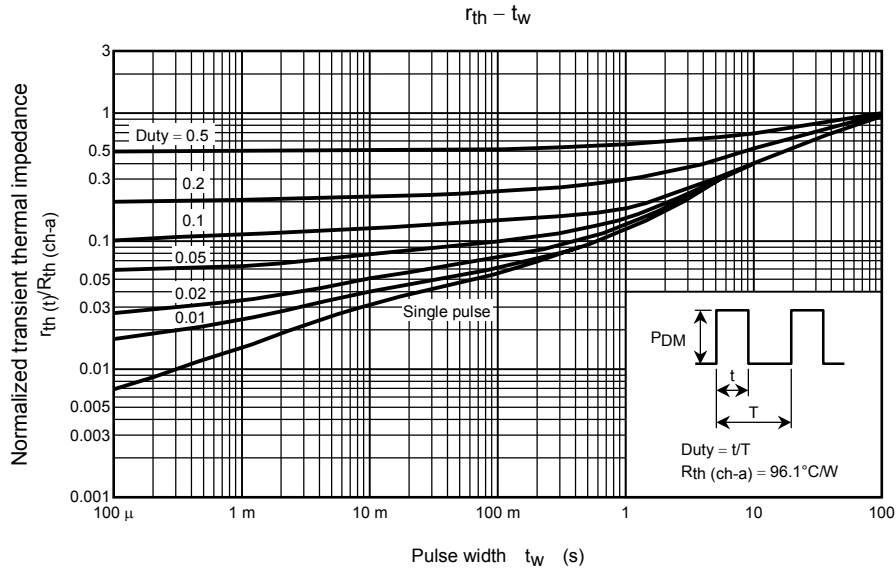
| Characteristics | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|-----------|---|-----|------|------|------|
| Continuous drain reverse current (Note 1) | I_{DR} | — | — | — | 0.5 | A |
| Pulse drain reverse current (Note 1) | I_{DRP} | — | — | — | 1.5 | A |
| Forward voltage (diode) | V_{DSF} | $I_{DR} = 0.5\text{ A}, V_{GS} = 0\text{ V}$ | — | — | -1.5 | V |
| Reverse recovery time | t_{rr} | $I_{DR} = 0.5\text{ A}, V_{GS} = 0\text{ V},$ | — | 190 | — | ns |
| Reverse recovery charge | Q_{rr} | $dI_{DR}/dt = 100\text{ A}/\mu\text{s}$ | — | 380 | — | nC |

Marking









$R_G = 25 \Omega$
 $V_{DD} = 90 \text{ V}, L = 100 \text{ mH}$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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